Exhibition fees

Exhibition fees	1 booth / 9m ² *including tax					
Non-Members	Yen 442,800					
Members *1	Yen 378,000					
Other exhibition related expenses						
Corner charge (per booth) *2	Yen 16,200					

How to apply

Please fill out the Application Form in consideration with follows:

- Carefully read the "Exhibition Regulations"
- Select the exhibition based on your product

The Secretariat Office will send the invoice. Based on the invoice, please make the payment by the due date.

Application deadline

Friday, February 12, 2016

Cancellation charges

If an exhibit is cancelled to suit the exhibitor's circumstances, cancellation charges (full or partial fees) shall apply as below

Date of receipt of written notice of cancellation	Cancellation charges		
By Friday, March 11, 2016	50% of booth fees		
From Saturday, March 12, 2016 onward	100% of booth fees		

Package booth

Yen 81.000 (excluding tax)

1 booth / 1 side open plan 2 booths / 1 side open plan



We are offering cost-effective package booth including basic furnishings and ornamentation as a set.

1 Set

1 light

1.3Kw

1.6Kw

The above prices are fees for furnishing and ornamentation only. Specifications and prices are subject to change. For the details, please refe to the Exhibitors Manual available at the Exhibitors' Briefing in March, 2016.

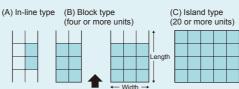
Schedule prior to the Exhibition

	January, 2016	February	March	April	Мау		June
Preparation for the exhibition		Application deadline Friday, February 12		Deadline for submission of application documents Mid-April		Installation period Monday, May 30 & Tuesday, May 31	Exhibition open Wednesday, June 1 to Friday, June 3
Preparation for promotion	Starting to put up posters		Starting business matching Starting to send e-mail newsletters	Sending invitations Starting registration to the exhibition			

Booth type

In-line type:

Block type:



*1 Members of the WECC member associations (CPCA, KPCA, TPCA, HKPCA, IPC, EIPC, and IPCA) *2 Based on the availability, corner booth is reserved.

2 side open plan

3 side open plan

Determination of Booth Location

- Determined at the Exhibitors' Briefing (scheduled on March 11, 2016)
- A first-come-first-served basis (earlier applicants get priority selection) for the overlaps of desired booth location
- On behalf of absentee, The Secretariat Office selects the booth location

The World's top-level, Industry-Academia Collaboration

Mount, Connect, Manufacture, and **Expand**

The Total Solution **Exhibition** for Electronic Equipment

Consists of :





Large Electronics Show 2016





Managed by

Japan Electronics Packaging and Circuits Association (JPCA) Kairo Kaikan 2F, 3-12-2, Nishiogikita, Suginami-ku, Tokyo 167-0042 TEL.03-5310-2020 FAX.03-5310-2021 E-mail: show@jpca.org



The Exhibition Guide



Microelectronics Show

WIRE Japan Show



Monotsukuri Fiesta 2016

Secretariat Office

ICS Convention Design, Inc.

Chiyoda Bldg. 1-5-18, Sarugakucho, Chiyoda-ku, Tokyo 101-8449 TEL.03-3219-3641 FAX.03-3219-3628 E-mail: jpcashow@ics-inc.co.jp

"Mount, Connect, Manufacture, and Expand" in The Total Solution Exhibition

- Highly specialized and focused
- Exhibition of large attendance from all over the world

Outline of the exhibition

Exhibition Period: Wednesday, June 1 to Friday, June 3, 2016 Venue: East Exhibition Hall 2 - 5, Tokyo Big Sight, Tokyo Japan Organizers: Japan Electronics Packaging and Circuits Association (JPCA)

- Japan Institute of Electronics Packaging (Japan Robot Association (72) Co-organizers: Electronic Device Industry News (Sangyo Times, Inc.)
- Electric Wire & Cable News (KOGYO TSUSHIN CO., ITD) Ministry of Economy Sponsors:

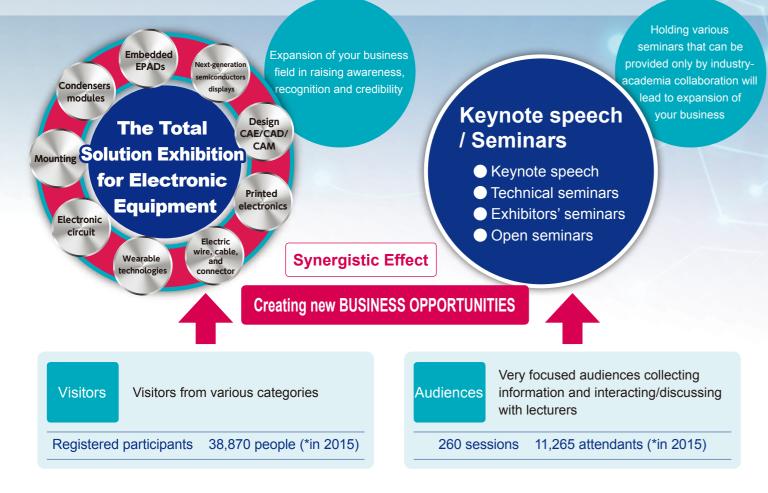
(Tentative)

Trade and Industry and Kanto Head Office of Organization for Small & Medium Enterprises and Regional Innovation, JAPAN

Overseas Cooperation:

World Electronic Circuits Council (WECC) Member Associates: China Printed Circuit Association (CPCA), European Institute of Printed Circuits (EIPC), Hong Kong Printed Circuit Association (HKPCA), IPC-Association Connecting Electronics Industries (IPC), Indian Printed Circuit Association (IPCA), Korea Printed Circuit Association (KPCA)., Taiwan Printed Circuit Association (TPCA) Managed by: Japan Electronics Packaging and Circuits Association (JPCA).

Secretariat Office: ICS Convention Design, Inc. Entrance fee: 1,000 yen (including tax) *Free Admission for visitors with invitations and those who have preregistered online.



Comprehensive electronics exhibition encompassing all products, technologies and services in electronic circuit production, development and research

Event with the allin participation of the electronic circuit industry

Collaboration with the various sectors from industry to academia

Collaboration with up and down stream

connecting with various categories as follows:

Outline of each exhibition and products to be exhibited

IPCA Show 2016

46th International Electronic Circuits Exhibition

Organizer: Japan Electronics Packaging and Circuits Association (JPCA)

PWB Technology

Exhibition

Printed wiring boards, Design process technologies, Materials for wiring boards. Manufacturing process technologies, distribution of equipment and materials, and environmental systems



Module Japan

Module substrate, Module mounting, Design, Module substrate / packaging materials, Manufacturing process technologies and equipment and materials. Distribution and environmental systems

Module JAPAN 2016

EMS Japan

Printed wiring mount board, Mounted module substrate, Manufacturing, mounting, assembling, and inspection contract services of various kinds of integrated circuits



Large Electronics Show 2016

Organizer: Japan Electronics Packaging and Circuits Association (JPCA) Co-organizer: Electronic Device Industry News (Sangyo Times, Inc.)

PE PROCESS

Printed electronics substrate, Design and analysis systems, high-performance materials, Printing and coating equipment / systems, Transportation systems, curing, drying, and sealing technologies, Products applying printed electronics



Device Engineering

Electronics parts, MEMS, and various kinds of devices. Design and analysis systems, Various kinds of nano-level m aterials. Micro processing equipment / systems, Inspection and assessment measurement techniques. Various products applying nanotechnology



SS (Solid-State) Lighting

LED/OLED (Organic EL) and their application products (lighting devices, energy, displays, touch panels, etc.), LED/OLED packaging materials, design and analysis systems, Inspection and assessment measurement techniques, LED/OLED manufacturing equipment / systems and related subsidiary materials



The Total Solution Exhibition for Electronic Equipment assures exhibitors

PCB manufactures, semiconductor designers/fabricators, electronic component manufactures, electric/electronic device manufactures, material/chemical suppliers, electric wire/cable manufactures, academia/research organizations, trading houses, etc.

2016 Microelectronics Show

30th Advanced Electronics Packaging Exhibition

Organizer: Japan Institute of electronics Packaging

ALL high-density mounting technologies

Academic Plaza eX-tech

JISSO PROTEC 2016

18th Jisso Process Technology Exhibition

Organizer: Japan Robot Association 📜

Electronic component placement machines and related equipment and systems. Semiconductor packaging machines and systems. Inspection / test equipment, Packaging design systems

WIRE Japan Show 2016

WIRE Japan Show (Electronic Wire, Cable, and Connector Exhibition)

Organizer: Japan Electronics Packaging and Circuits Association (JPCA)

Co-organizer: Electric Wire & Cable News (KOGYO TSUSHIN CO. LTD)

Industrial equipment, Wires, cables, and connectors, Electric wire processors, wiring member, and wire harness. Electric wire or cable measuring instrument, Manufacturing equipment (wire, cables, and harness), Inspection equipment

Monotsukuri Fiesta 2016

Organizer: Japan Electronics Packaging and Circuits Association **IPCA**

Co-organizer: Electronic Device Industry News (Sangyo Times, Inc.)

3D-MID Pavilion

- Shaping the Dream Supporting Exhibition for the Next Application
- NEDIA Electronic Device Exhibition
- Sensor / IoT pavilion
- Pavilion of local governments (Tentative)

